

Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED



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Typical Applications

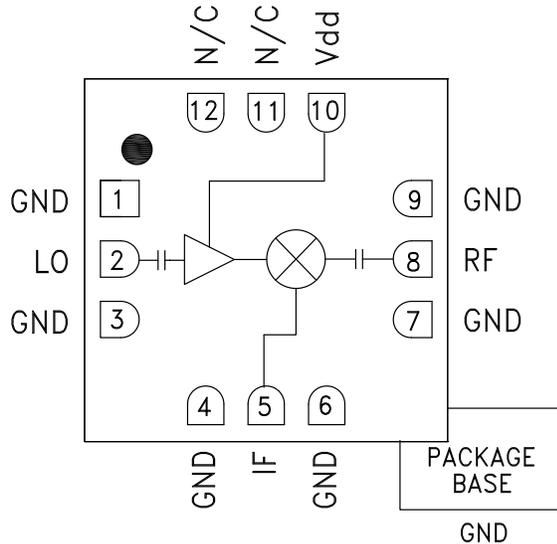
The HMC338LC3B is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- Test Equipment & Sensors
- Military End-Use
- SAT COM

Features

- Integrated LO Amplifier: -5 dBm Input
- Sub-Harmonically Pumped (x2) LO
- DC - 3 GHz Wideband IF
- Single Positive Supply: +4V @ 31mA
- 12 Lead 3x3mm SMT Package: 9mm²

Functional Diagram



General Description

The HMC338LC3B is a 24 - 34 GHz Sub-harmonically Pumped (x2) MMIC Mixer with an integrated LO amplifier in a leadless RoHS compliant SMT package. The 2LO to RF isolation is excellent at 30 dB, eliminating the need for additional filtering. The LO amplifier is a single bias (+3V to +4V) design with a nominal -5 dBm drive requirement. The RF and LO ports are DC blocked and matched to 50 Ohms for ease of use while the IF covers DC to 3 GHz. The HMC338LC3B eliminates the need for wire bonding, allowing use of surface mount manufacturing techniques.

Electrical Specifications, $T_A = +25\text{ }^\circ\text{C}$, As a Function of Vdd

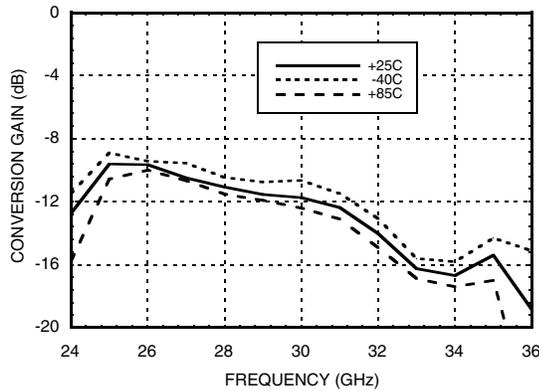
Parameter	IF = 1 GHz LO = -5 dBm & Vdd = +4V			IF = 1 GHz LO = -5 dBm & Vdd = +4V			IF = 1 GHz LO = -5 dBm & Vdd = +3V			Units
	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	
Frequency Range, RF	24 - 27			25 - 31			31 - 34			GHz
Frequency Range, LO	11.5 - 13			12 - 15			15 - 16.5			GHz
Frequency Range, IF	DC - 3			DC - 3			DC - 3			GHz
Conversion Loss		11	15		11	15		15	18	dB
2LO to RF Isolation	25	30		25	33		30	40		dB
2LO to IF Isolation	37	45		37	50		40	50		dB
IP3 (Input)		9			13			14.5		dBm
1 dB Compression (Input)		3			5			6.5		dBm
Supply Current (Idd)		31	40		31	40		29	40	mA

*Unless otherwise noted, all measurements performed as downconverter, IF= 1 GHz.

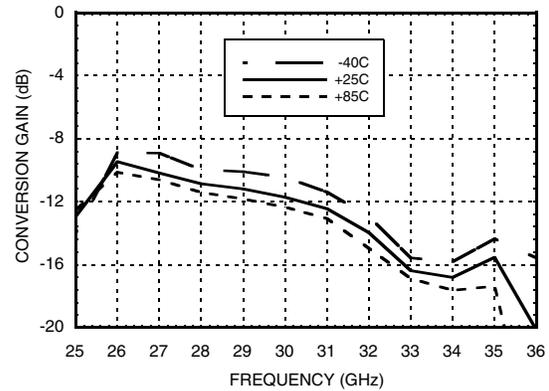


GaAs MMIC SUB-HARMONIC SMT MIXER, 24 - 34 GHz

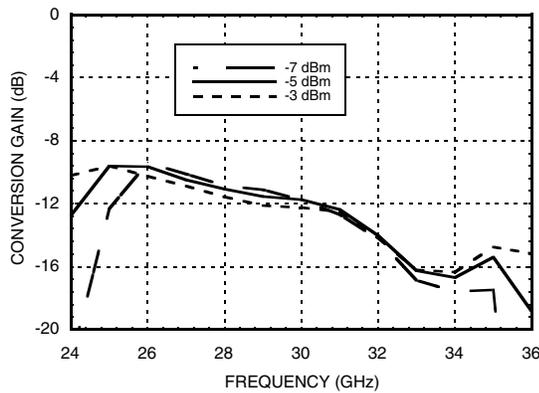
Conversion Gain vs. Temperature @ LO = -4 dBm, Vdd = +4V



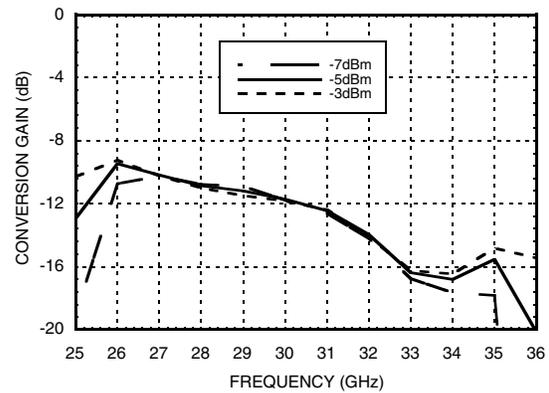
Conversion Gain vs. Temperature @ LO = -4 dBm, Vdd = +3V



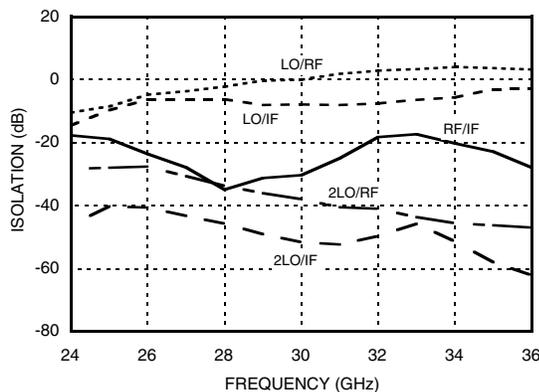
Conversion Gain vs. LO Drive @ Vdd = +4V



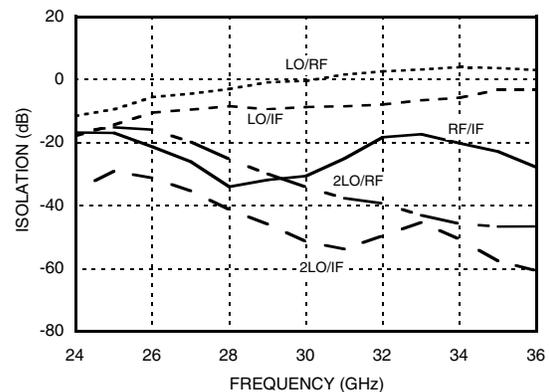
Conversion Gain vs. LO Drive @ Vdd = +3V

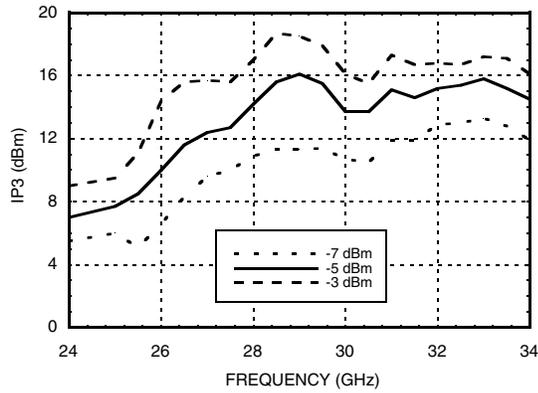
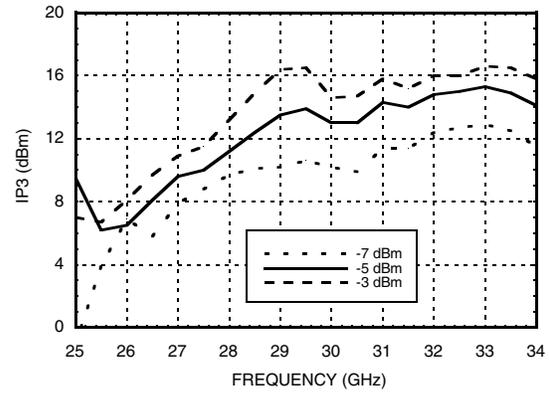
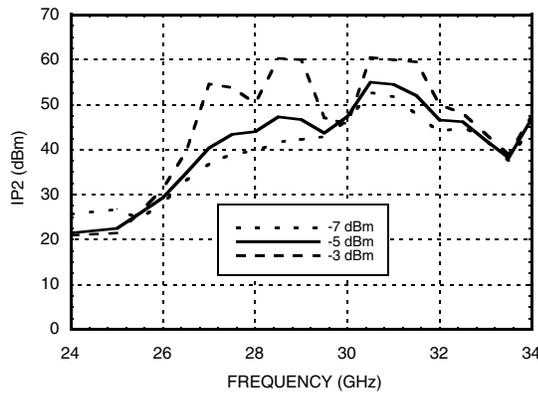
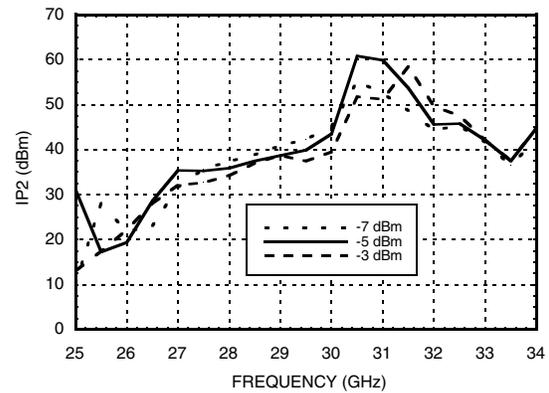
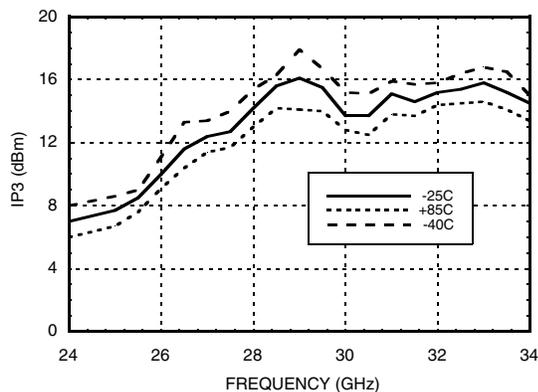
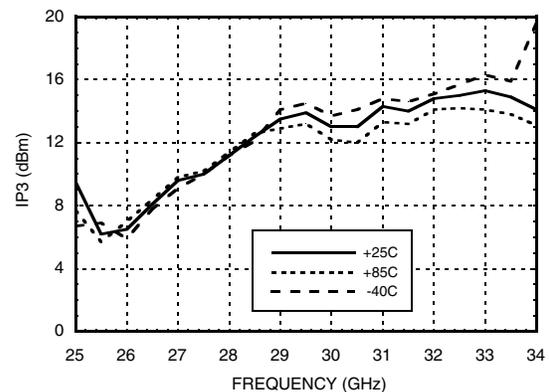


Isolation @ Vdd = +4V



Isolation @ Vdd = +3V



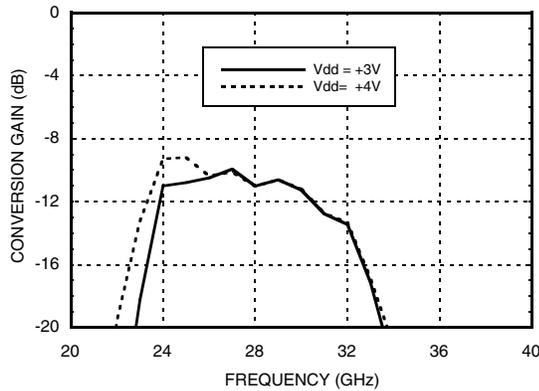
Input IP3 vs. LO Drive @ Vdd = +4V *

Input IP3 vs. LO Drive @ Vdd = +3V *

Input IP2 vs. LO Drive @ Vdd = +4V *

Input IP2 vs. LO Drive @ Vdd = +3V *

**Input P1dB vs. Temperature @
LO = -4 dBm, Vdd = +4V**

**Input P1dB vs. Temperature @
LO = -4 dBm, Vdd = +3V**


* Two-tone input power = -10 dBm each tone, 1 MHz spacing.

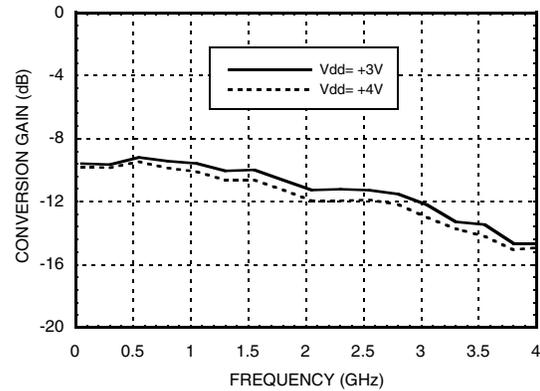


GaAs MMIC SUB-HARMONIC SMT MIXER, 24 - 34 GHz

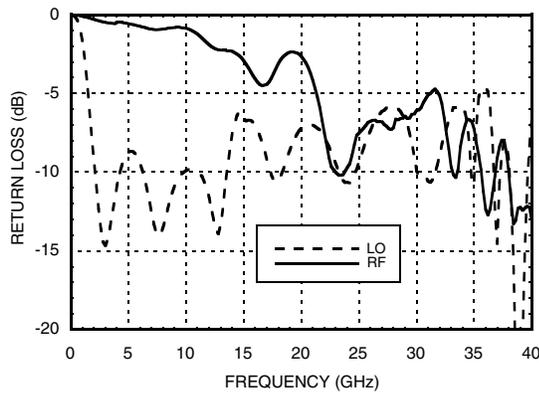
Upconverter Performance Conversion Gain @ LO = -4 dBm



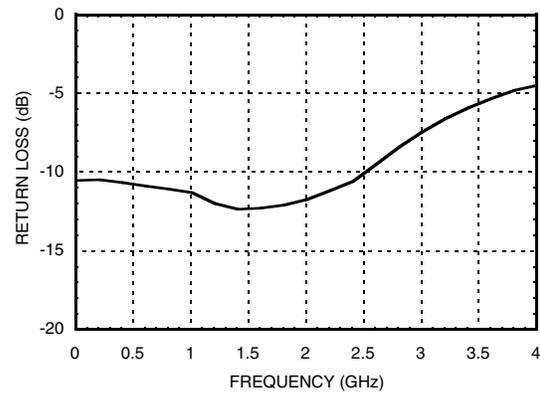
IF Bandwidth @ LO = -4 dBm



RF & LO Return Loss @ LO = -4 dBm



IF Return Loss @ LO = -4 dBm



MxN Spurious Outputs @ IF Port, Vdd = 4V

mRF	nLO					
	±5	±4	±3	±2	±1	0
-3						
-2	62					
-1	75	42	67			
0			12	34	-8	
1				0	55	13
2		65	51		68	
3	95					

RF = 31 GHz @ -10 dBm
LO = 15 GHz @ -5 dBm
All values in dBc below IF power level (1RF - 2LO)
Measured as downconverter

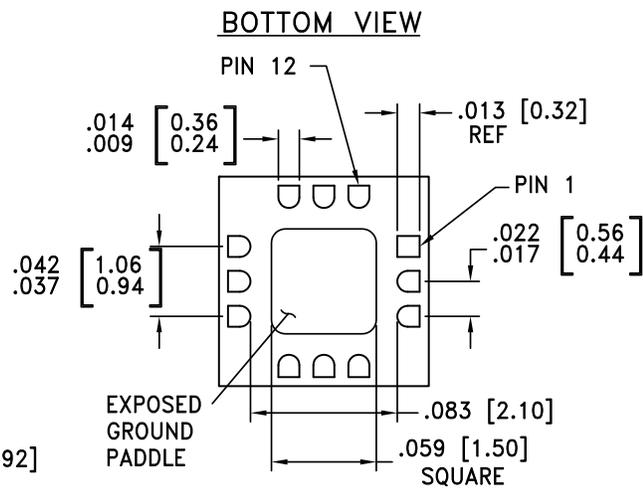
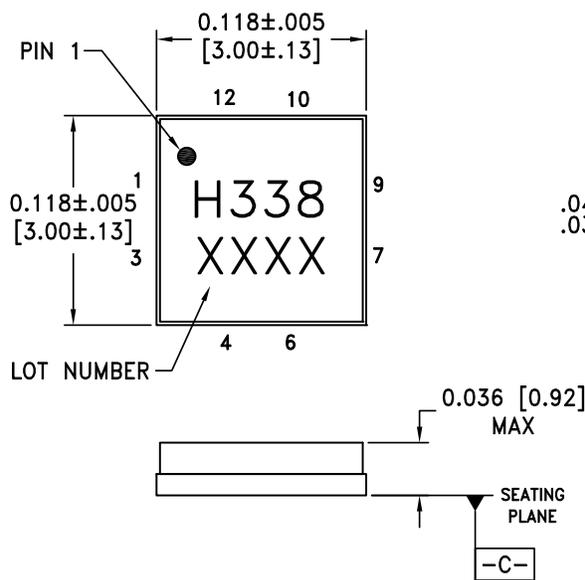
MxN Spurious Outputs @ RF Port, Vdd = 4V

mIF	nLO			
	±3	±2	±1	0
-3		42		
-2	25	60	40	
-1	45	0	41	
0	-3	23	-17	
1	49	0	38	13
2	32	63	30	67
3		46		57

IF = 1 GHz @ -10 dBm
LO = 15 GHz @ -5 dBm
All values in dBc below IF power level (1IF - 2LO)
Measured as upconverter

Absolute Maximum Ratings

RF / IF Input (Vdd = +5V)	+10 dBm
LO Drive (Vdd = +5V)	+13 dBm
Vdd	5.5V
Channel Temperature	175 °C
Continuous P _{diss} (Ta = 85 °C) (derate 2.52 mW/°C above 85 °C)	227 mW
Thermal Resistance (junction to ground paddle)	397 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C


**ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS**
Outline Drawing

NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA.
2. LEAD AND GROUND PADDLE PLATING: GOLD FLASH OVER NICKEL.
3. DIMENSIONS ARE IN INCHES (MILLIMETERS).
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
5. CHARACTERS TO BE HELVETICA MEDIUM, .025 HIGH, BLACK INK, OR LASER MARK LOCATED APPROX. AS SHOWN.
6. PACKAGE WARP SHALL NOT EXCEED 0.05MM DATUM $\square-C$
7. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

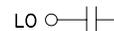
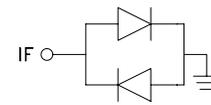
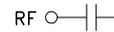
Package Information

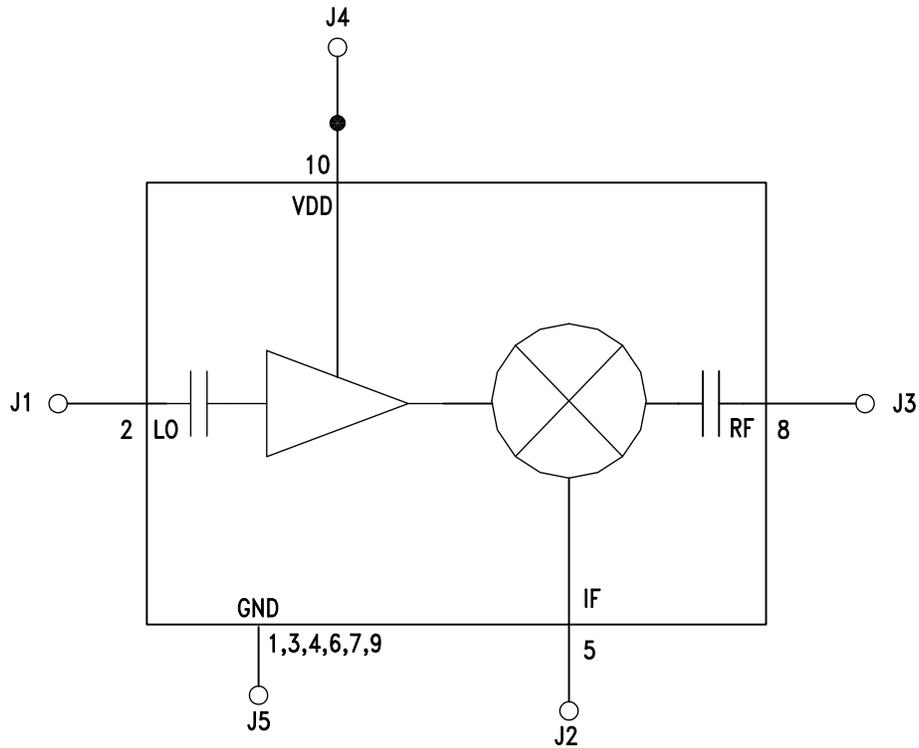
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[2]
HMC338LC3B	Alumina, White	Gold over Nickel	MSL3 ^[1]	H338 XXXX

[1] Max peak reflow temperature of 260 °C

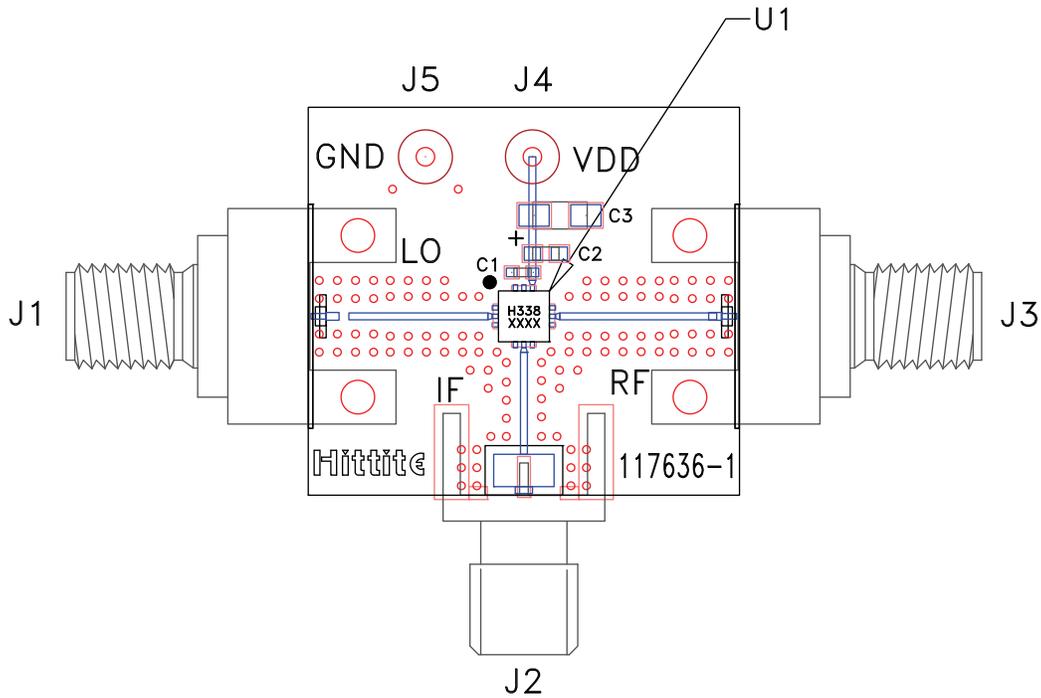
[2] 4-Digit lot number XXXX


Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 4, 6, 7, 9	GND	Package bottom must also be connected to RF/DC ground.	
2	LO	This pin is AC coupled and matched to 50 Ohms.	
5	IF	This pin is DC coupled and should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. Any applied DC voltage to this pin will result in die non-function and possible die failure.	
8	RF	This pin is AC coupled and matched to 50 Ohms.	
10	Vdd	Power supply for the LO Amplifier.	
11, 12	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	

Application Circuit

Evaluation PCB



List of Materials for Evaluation PCB 117638 [1]

Item	Description
J1 - J3	PCB Mount Connector
J4, J5	DC Pin
U1	HMC338LC3B Mixer
PCB [2]	117636 Evaluation PCB

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Arlon 25 FR

The circuit board used in this application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

Mouser Electronics

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